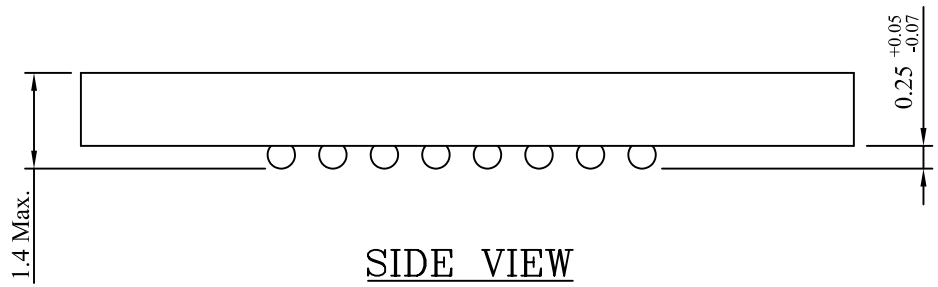
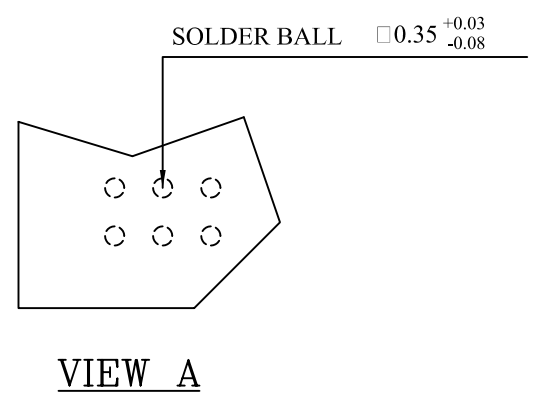
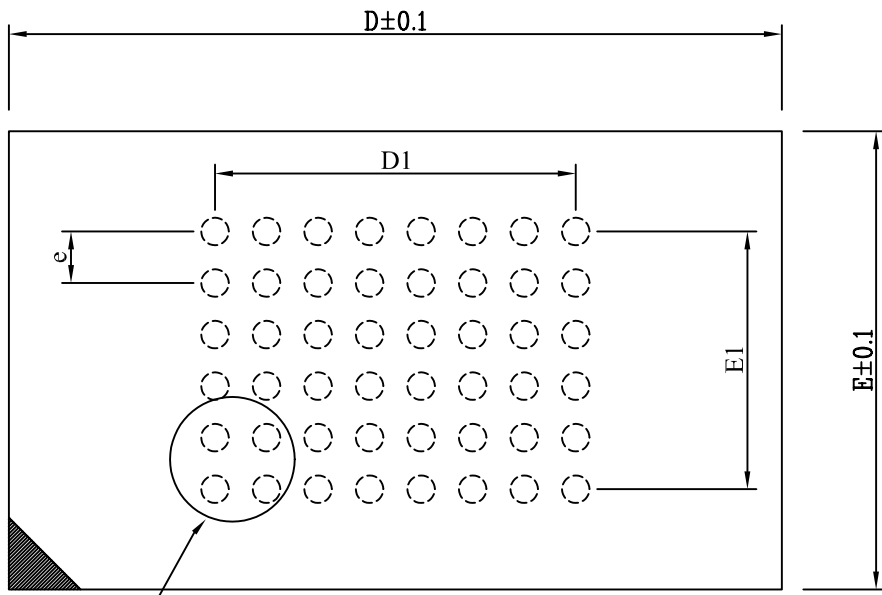


Title: Package outline for 48 ball Mini BGA-8x10mm



BALL PITCH e = 0.75				
D	E	N	D1	E1
10.0	8.0	48	5.25	3.75



TOP VIEW

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS.
2. PIN#1 DOT MARKING BY LASER OR PAD PRINT.
3. SYMBOL "N" IS THE NUMBER OF SOLDER BALLS.

DWG. NO.	ORIGINATOR	ISSUE DATE	REV.
PC600-0022	Yuki_Yeh	28-Feb.-'05	0.